

# EC103D1 Sensitive gate thyristor Rev. 01 — 1 November 2001

**Product data** 

## 1. Description

Very sensitive gate thyristor intended to be interfaced directly to low power gate trigger circuits, with very low drive current capability.

Product availability:

EC103D1 in SOT54 (TO-92).

#### 2. Features

- Blocking voltage to 400 V
- On-state RMS current to 0.8 A
- Ultra low gate trigger current
- Low cost package.

## 3. Applications

- Earth leakage circuit breakers
- Solid state relays
- General purpose switching.

## 4. Pinning information

Table 1: Pinning - SOT54 (TO-92), simplified outline and symbol

Pin	Description	Simplified outline	Symbol	
1	anode (a)	1		1
2	gate (g)	23	<b>=</b>	<b>▼</b>
3	cathode (k)	MSB0:	MSB033	
		SOT54 (TO-92)		





Sensitive gate thyristor

## 5. Quick reference data

Table 2: Quick reference data

Symbol	Parameter	Conditions	Тур	Max	Unit
$V_{DRM}$	repetitive peak off-state voltage 25 °C ≤ T <sub>j</sub> ≤ 125 °C		-	400	V
$V_{RRM}$	repetitive peak reverse voltage		-	400	V
$I_{T(RMS)}$	on-state current (RMS value)		-	8.0	Α
I <sub>TSM</sub>	non-repetitive peak on-state current		-	8.0	А

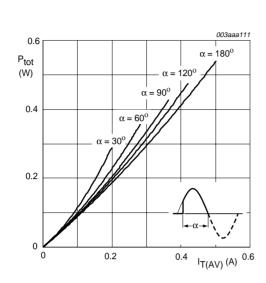
# 6. Limiting values

**Table 3: Limiting values** 

In accordance with the Absolute Maximum Rating System (IEC 60134).

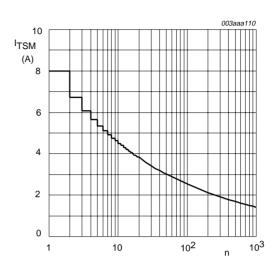
Symbol	Parameter	Conditions	Min	Max	Unit
$V_{DRM}$	repetitive peak off-state voltage	25 °C ≤ T <sub>j</sub> ≤ 125 °C	-	400	V
$V_{RRM}$	repetitive peak reverse voltage		-	400	V
I <sub>T(AV)</sub>	average on-state current	half sine wave; T <sub>lead</sub> ≤ 83 °C	-	0.5	Α
I <sub>T(RMS)</sub>	on-state current (RMS value)	all conduction angles	-	0.8	Α
I <sub>TSM</sub>	non-repetitive peak on-state current	half sine wave; $T_j = 25$ °C prior to surge			
		t = 10 ms	-	8.0	Α
		t = 8.3 ms	-	9.0	Α
l <sup>2</sup> t	I <sup>2</sup> t for fusing	t = 10 ms	-	0.32	A <sup>2</sup> s
dl <sub>T</sub> /dt	rate of rise on-state current	$I_{TM} = 2.0 \text{ A}; I_G = 10 \text{ mA};$ $dI_G/dt = 100 \text{ mA}/\mu\text{s}$	-	50	A/μs
I <sub>GM</sub>	peak gate current		-	1.0	A
$V_{GM}$	peak gate voltage		-	5.0	V
$V_{RGM}$	peak reverse gate voltage		-	5.0	V
$P_GM$	peak gate power		-	2.0	W
$P_{G(AV)}$	average gate power	over any 20 ms period	-	0.1	W
T <sub>stg</sub>	storage temperature		-40	+150	°C
Tj	operating junction temperature		-	+125	°C

#### Sensitive gate thyristor



 $\alpha$  = conduction angle

Fig 1. Maximum on-state dissipation as a function of average on-state current; typical values.



n = number of cycles at f = 50 Hz

Fig 2. Maximum permissible non-repetitive peak on-state current as a function of number of cycles for sinusoidal currents; typical values.

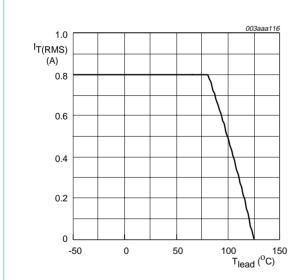
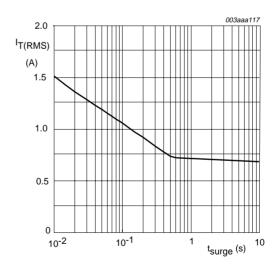


Fig 3. Maximum permissible on-state current (RMS value) as a function of lead temperature; typical values.



 $f = 50 \text{ Hz}; T_{lead} \le 83^{\circ}\text{C}.$ 

Fig 4. Maximum permissible repetitive on-state current (RMS value) as a function of surge duration for sinusoidal currents; typical values.

Sensitive gate thyristor

## 7. Thermal characteristics

**Table 4: Thermal characteristics** 

Symbol	Parameter	Conditions	Value	Unit
R <sub>th(j-lead)</sub>	thermal resistance from junction to lead		80	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient	mounted on a printed circuit board; lead length = 4 mm	150	K/W

## 7.1 Transient thermal impedance

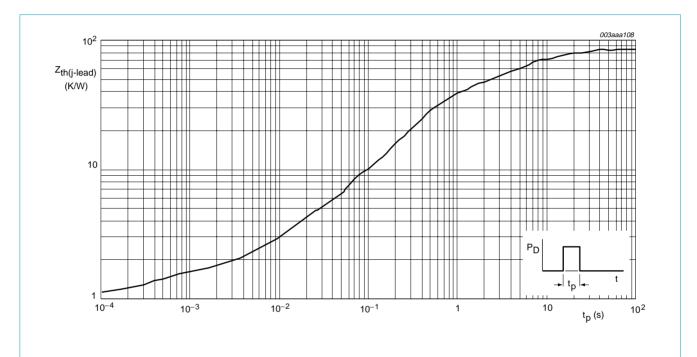


Fig 5. Transient thermal impedance from junction to lead as a function of pulse duration.

### Sensitive gate thyristor

## 8. Characteristics

**Table 5: Characteristics** 

 $T_i = 25 \,^{\circ}C$  unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
-	aracteristics			- 7 P		<b></b>
				_		_
I <sub>GT</sub>	gate trigger current	$V_D = 12 \text{ V}$ ; $I_T = 0.1 \text{ A}$ ; gate open circuit	-	3	12	μΑ
IL	latching current	$V_D$ = 12 V; $I_{GT}$ = 0.5 mA; $R_{GK}$ = 1 $k\Omega$	-	2	6	mA
I <sub>H</sub>	holding current		-	2	5	mA
V <sub>T</sub>	on-state voltage	I <sub>T</sub> = 1.0 A	-	1.2	1.35	V
$V_{GT}$	gate trigger voltage	I <sub>T</sub> = 10 mA; gate open circuit				
		V <sub>D</sub> = 12 V	-	0.5	0.8	V
		$V_D = V_{DRM (max)}; T_j = 125 ^{\circ}C$	0.2	0.3	-	V
I <sub>D</sub>	off-state current	$V_D = V_{DRM (max)}; V_R = V_{RRM (max)};$	-	50	100	μΑ
I <sub>R</sub>	reverse current	$T_j = 125 ^{\circ}C; R_{GK} = 1  k\Omega$	-	50	100	μΑ
Dynamic	characteristics					
dV <sub>D</sub> /dt	rate of rise of off-state voltage	$V_D$ = 0.67 $V_{DRM(max)}$ ; $T_{case}$ = 125 °C; exponential waveform; $R_{GK}$ = 1 $k\Omega$	-	25	-	V/μs
t <sub>gt</sub>	gate controlled turn-on time	$I_{TM} = 2.0 \text{ A}; V_D = V_{DRM(max)};$ $I_G = 10 \text{ mA}; dI_G/dt = 0.1 \text{ A} /\mu\text{s}$	-	2	-	μs
t <sub>q</sub>	commutated turn-off time	$\begin{split} &V_D = 0.67 \ V_{DRM(max)}; \ T_j = 125 \ ^{\circ}C; \\ &I_{TM} = 1.6 \ A; \ V_R = 35 \ V; \\ &dI_{TM}/dt = 30 \ A \ /\mu s; \ dV_D/dt = 2 \ V/\mu s; \\ &R_{GK} = 1 \ k\Omega \end{split}$	-	100	-	μs

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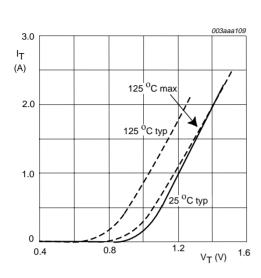
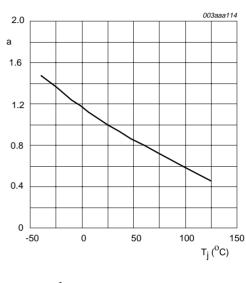
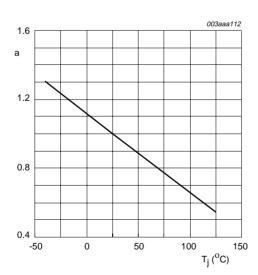


Fig 6. On-state current as a function of on-state voltage; typical and maximum values.



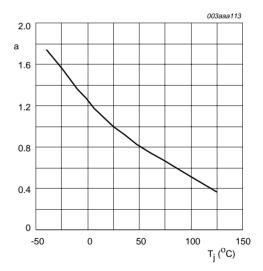
$$a = \frac{I_{L(Tj)}}{I_{L(25^{\circ}C)}}$$

Fig 7. Normalized latching current as a function of junction temperature; typical values.



 $a = \frac{V_{GT(Tj)}}{V_{GT(25^{\circ}C)}}$ 

Fig 8. Normalized gate trigger voltage as a function of junction temperature; typical values.



$$a = \frac{I_{GT(Tj)}}{I_{GT(25^{\circ}C)}}$$

Fig 9. Normalized gate trigger current as a function of junction temperature; typical values.

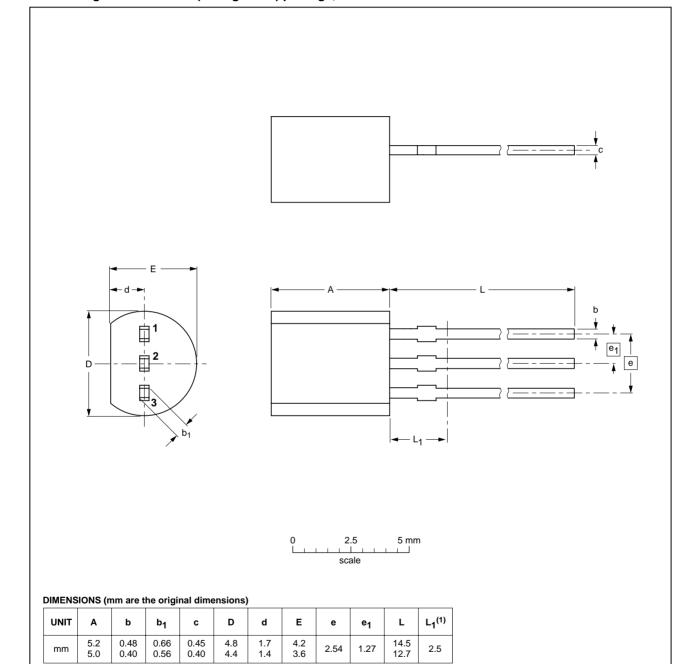
EC103D1

Sensitive gate thyristor

## 9. Package outline

Plastic single-ended leaded (through hole) package; 3 leads

SOT54



#### Note

1. Terminal dimensions within this zone are uncontrolled to allow for flow of plastic and terminal irregularities.

OUTLINE		REFERENCES			EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ		PROJECTION	1330E DATE
SOT54		TO-92	SC-43			97-02-28

Fig 10. SOT54 (TO-92).

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Sensitive gate thyristor

## 10. Revision history

#### **Table 6: Revision history**

Rev	Date	CPCN	Description
01	20011101	-	Product data; initial version

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#### 11. Data sheet status

Data sheet status <sup>[1]</sup>	Product status <sup>[2]</sup>	Definition
Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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<sup>[1]</sup> Please consult the most recently issued data sheet before initiating or completing a design.

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**Short-form specification** — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

**Limiting values definition** — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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<sup>[2]</sup> The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.

Sensitive gate thyristor

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EC103D1

#### Sensitive gate thyristor

#### **Contents**

1	Description
2	Features 2
3	Applications
4	Pinning information
5	Quick reference data
6	Limiting values
7	Thermal characteristics
7.1	Transient thermal impedance
8	Characteristics6
9	Package outline
10	Revision history
11	Data sheet status
12	Definitions 10
13	Disclaimers 10

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